

74ALVT162823

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

Rev. 4 — 25 June 2024

Product data sheet

1. General description

The 74ALVT162823 is an 18-bit positive-edge triggered D-type flip-flop with 30 Ω termination resistors, 3-state outputs reset and enable.

The device can be used as two 9-bit flip-flops or one 18-bit flip-flop. The device features clock (nCP), clock enable (n \overline{CE}), master reset (n \overline{MR}) and output enable (n \overline{OE} , inputs each controlling 9-bits. When n \overline{CE} is LOW, the flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (nCP) transition. A HIGH on n \overline{OE} causes the outputs to assume a high-impedance OFF-state. Operation of the n \overline{OE} input does not affect the state of the flip-flops. A LOW on n \overline{MR} will reset the flip-flops LOW. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs.

2. Features and benefits

- · Two sets of high speed parallel registers with positive edge-triggered D-type flip-flops
- 5 V I/O compatible
- Ideal where high speed, light loading or increased fan-in are required with MOS microprocessors
- · Bus hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Power-up 3-state
- Power-up reset
- Output capability: +12 mA to −12 mA
- Outputs include series resistance of 30 Ω making external termination resistors unnecessary
- Latch-up protection:
 - JESD78: exceeds 500 mA
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C

3. Ordering information

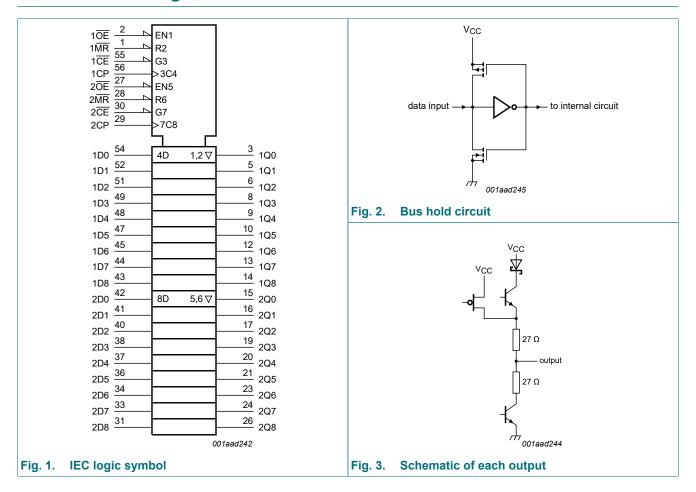
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74ALVT162823DGG	−40 °C to +85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1

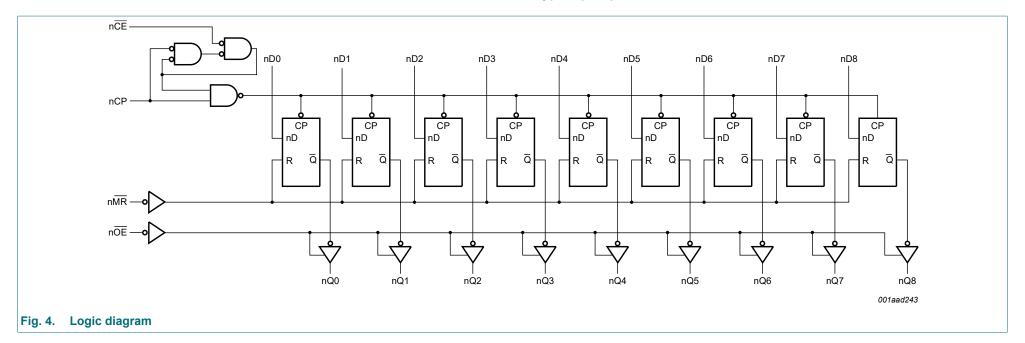


18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

4. Functional diagram



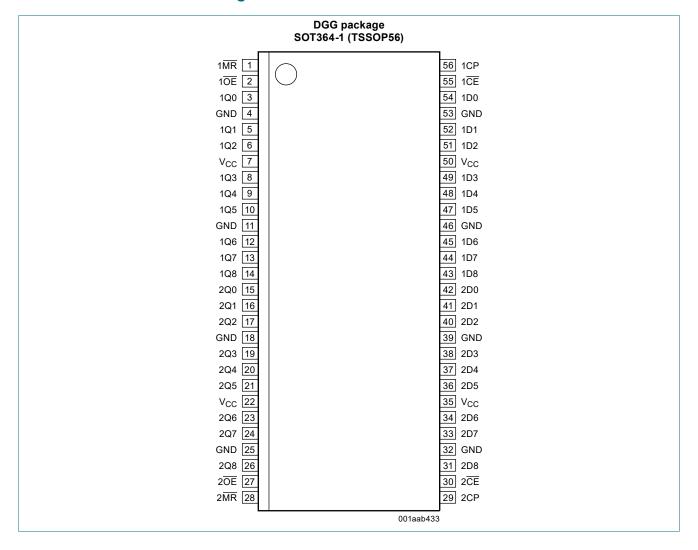
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5. Pinning information

5.1. Pinning



18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7, 1D8	54, 52, 51, 49, 48, 47, 45, 44, 43	data inputs
1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7, 1Q8	3, 5, 6, 8, 9, 10, 12, 13, 14	data outputs
2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7, 2D8	42, 41, 40, 38, 37, 36, 34, 33, 31	data inputs
2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7, 2Q8	15, 16, 17, 19, 20, 21, 23, 24, 26	data outputs
1MR, 2MR	1, 28	master reset input (active-LOW)
1 OE , 2 OE	2, 27	output enable inputs (active LOW)
1CP, 2CP	56, 29	clock pulse inputs (active rising edge)
1CE, 2CE	55, 30	clock enable input (active-LOW)
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)
V _{CC}	7, 22, 35, 50	supply voltage

6. Functional description

Table 3. Function table

Operating mode	Input [1]	Input [1]								
	nŌĒ	nMR	nCE	nCP	nDn	nQn				
Clear	L	L	Х	X	X	L				
Load and read data	L	Н	L ↑		h	Н				
					I	L				
Hold	L	Н	Н	NC	X	NC				
High-impedance	Н	X	X	Х	X	Z				

^[1] H = HIGH voltage level;

 $h = HIGH \ voltage \ level \ one \ set-up \ time \ prior \ to \ the \ LOW-to-HIGH \ clock \ transition;$

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

NC = no change;

X = don't care;

Z = high-impedance OFF-state;

 \uparrow = LOW-to-HIGH clock transition;

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+7.0	V
V _O	output voltage	output in OFF-state or HIGH-state [1]	-0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V	-	-50	mA
I _{OK}	output clamping current	V _O < 0 V	-	-50	mA
Io	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-	-64	mA
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[2]	-	150	°C

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC} = 2.	5 V					•
V _{CC}	supply voltage			-	2.7	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-	-	-8	mA
I _{OL}	LOW-level output current		-	-	12	mA
Δt/Δν	input transition rise or fall rate	outputs enabled	-	-	10	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
V _{CC} = 3.	3 V		'		'	
V _{CC}	supply voltage		3.0	-	3.6	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-	-	-12	mA
I _{OL}	LOW-level output current		-	-	12	mA
Δt/Δν	input transition rise or fall rate	outputs enabled	-	-	10	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C

^[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; $T_{amb} = -40$ °C to +85 °C; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
V _{CC} = 2.	5 V ± 0.2 V						
V _{IK}	input clamping voltage	V _{CC} = 2.3 V; I _{IK} = -18 mA		-	-0.85	-1.2	V
V _{IH}	HIGH-level input voltage			1.7	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.7	V
V _{OH}	HIGH-level output voltage	V _{CC} = 2.3 V; I _O = -8 mA		1.7	2.5	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 2.3 V; I _O = 12 mA		-	0.3	0.5	V
V _{OL(pu)}	power-up LOW-level output voltage	V_{CC} = 2.7 V; I_O = 1 mA; V_I = V_{CC} or GND	[2]	-	0.2	0.55	V
I _I	input leakage current	control pins					
		V _{CC} = 2.7 V; V _I = GND		-	0.1	±1	μA
		V _{CC} = 2.7 V; V _I = 5.5 V		-	0.1	10	μΑ
		I/O data pins	[3]				
		V _{CC} = 2.7 V; V _I = 5.5 V		-	0.1	10	μΑ
		V _{CC} = 2.7 V; V _I = V _{CC}		-	0.5	1	μΑ
		V _{CC} = 2.7 V; V _I = 0 V		-	0.1	-5	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ V to } 4.5 \text{ V}$		-	0.1	±100	μA
I _{BHL}	bus hold LOW current	data inputs; V _{CC} = 2.5 V; V _I = 0.7 V	[4]	-	100	-	μA
I _{BHH}	bus hold HIGH current	data inputs; V _{CC} = 2.5 V; V _I = 1.7 V	[4]	-	-70	-	μA
I _{EX}	external current	output HIGH-state when $V_O > V_{CC}$; $V_O = 5.5 \text{ V}$; $V_{CC} = 2.5 \text{ V}$		-	10	125	μA
I _{O(pu\pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_I = \text{GND or } V_{CC}$	[5]	-	1	±100	μA
l _{OZ}	OFF-state output current	V_{CC} = 2.7 V; V_I = V_{IL} or V_{IH}					
		output HIGH state; V _O = 2.3 V		-	0.5	5	μΑ
		output LOW-state; V _O = 0.5 V		-	0.5	-5	μΑ
I _{CC}	supply current	$V_{CC} = 2.7 \text{ V}; V_{I} = \text{GND or } V_{CC}; I_{O} = 0 \text{ A}$					
		outputs HIGH-state		-	0.04	0.1	mA
		outputs LOW-state		-	2.7	4.5	mA
		outputs disabled	[6]	-	0.04	0.1	mA
ΔI _{CC}	additional supply current	per input pin; V _{CC} = 2.3 V to 2.7 V; one input at V _{CC} - 0.6 V, other inputs at V _{CC} or GND	[7]	-	0.04	0.4	mA
Cı	input capacitance	$V_I = 0 \text{ V or } V_{CC}$		-	3	-	pF
Co	output capacitance	V _{I/O} = 0 V or 3.0 V		-	9	-	pF
V _{CC} = 3.	3 V ± 0.3 V	1					
V _{IK}	input clamping voltage	V _{CC} = 3.0 V; I _{IK} = -18 mA		-	-0.85	-1.2	V
V _{IH}	HIGH-level input voltage			2.0	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.8	V
V _{OH}	HIGH-level output voltage	V _{CC} = 3.0 V; I _O = -12 mA		2.0	2.3	-	V
		T	1		1		1

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Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
V _{OL(pu)}	power-up LOW-level output voltage	$V_{CC} = 3.6 \text{ V}; I_{O} = 1 \text{ mA}; V_{I} = V_{CC} \text{ or GND}$	[2]	-	-	0.55	V
lı	input leakage current	control pins					
		V_{CC} = 3.6 V; V_{I} = V_{CC} or GND		-	0.1	±1	μΑ
		V _{CC} = 0 V or 3.6 V; V _I = 5.5 V		-	0.1	10	μA
		I/O data pins	[3]				
		V _{CC} = 3.6 V; V _I = 5.5 V		-	0.1	10	μA
		V _{CC} = 3.6 V; V _I = V _{CC}		-	0.5	1	μA
		V _{CC} = 3.6 V; V _I = 0 V		-	0.1	-5	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ V to } 4.5 \text{ V}$		-	0.1	±100	μΑ
I _{BHL}	bus hold LOW current	data inputs; V _{CC} = 3 V; V _I = 0.8 V		75	130	-	μΑ
I _{BHH}	bus hold HIGH current	data inputs; V _{CC} = 3 V; V _I = 2.0 V		-75	-140	-	μA
I _{BHLO}	bus hold LOW overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[8]	500	-	-	μA
I _{внно}	bus hold HIGH overdrive current	data inputs; V _{CC} = 3.6 V; V _I = 0 V to 3.6 V [8]		-500	-	-	μA
I _{EX}	external current	output HIGH-state when $V_O > V_{CC}$; $V_O = 5.5 \text{ V}$; $V_{CC} = 3.0 \text{ V}$		-	10	125	μA
I _{O(pu\pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_I = \text{GND or } V_{CC}$	[9]	-	1	±100	μA
l _{OZ}	OFF-state output current	$V_{CC} = 3.6 \text{ V}; V_I = V_{IL} \text{ or } V_{IH}$					
		output HIGH state; V _O = 3.0 V		-	0.5	5	μA
		output LOW-state; V _O = 0.5 V		-	0.5	-5	μA
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = \text{GND or } V_{CC}; I_O = 0 \text{ A}$					
		outputs HIGH-state		-	0.05	0.1	mA
		outputs LOW-state		-	3.9	5.5	mA
		outputs disabled	[6]	-	0.06	0.1	mA
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 3 V to 3.6 V; one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND	[7]	-	0.04	0.4	mA
C _I	input capacitance	t capacitance V _I = 0 V or V _{CC}			3	-	pF
Co	output capacitance $V_{I/O} = 0 \text{ V or } 3.0 \text{ V}$				9	-	pF

^[1] All typical values for V_{CC} = 2.5 V ± 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C. All typical values for V_{CC} = 3.3 V ± 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

- [2] For valid test results, data must not be loaded into the flip-flops after applying power.
- [3] Unused pins at V_{CC} or GND.
- [4] Not guaranteed.
- [5] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.

From V_{CC} = 1.2 V to V_{CC} = 2.5 V ± 0.2 V a transition time of 100 μs is permitted. This parameter is valid for T_{amb} = 25 °C only.

- [6] I_{CC} is measured with outputs pulled up to V_{CC} or pulled down to ground.
- [7] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.
- [8] This is the bus hold overdrive current required to force the input to the opposite logic state.
- [9] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.

From V_{CC} = 1.2 V to V_{CC} = 3.3 V \pm 0.3 V a transition time of 100 μs is permitted. This parameter is valid for T_{amb} = 25 °C only.

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10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); T_{amb} = -40 °C to +85 °C; for test circuit see Fig. 9.

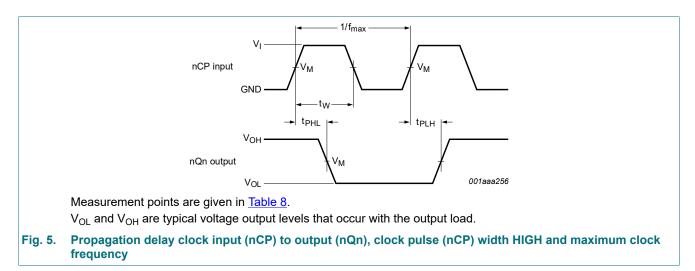
Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V _{CC} = 2.	5 V ± 0.2 V					
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see Fig. 5	2.1	3.7	5.8	ns
t _{PHL}	HIGH-to-LOW propagation delay	nCP to nQn; see Fig. 5	2.0	2.8	4.6	ns
		nMR to nQn; see Fig. 7	2.0	3.0	4.6	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see Fig. 8	2.8	4.4	6.6	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see Fig. 8	2.0	3.4	5.2	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see Fig. 8	2.3	3.2	4.6	ns
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see Fig. 8	2.0	2.5	3.5	ns
t _{su(H)}	set-up time HIGH	nDn to nCP; see Fig. 6	1.0	0.5	-	ns
		nCE to nCP; see Fig. 6	1.0	0.2	-	ns
t _{su(L)}	set-up time LOW	nDn to nCP; see Fig. 6	2.0	1.3	-	ns
		nCE to nCP; see Fig. 6	0.5	-0.1	-	ns
t _{h(H)}	hold time HIGH	nDn to nCP; see Fig. 6	0.1	-1.4	-	ns
		nCE to nCP; see Fig. 6	1.0	0.2	-	ns
t _{h(L)}	hold time LOW	nDn to nCP; see Fig. 6	0.1	-0.5	-	ns
		nCE to nCP; see Fig. 6	1.0	-0.1	-	ns
t _W	pulse width	nCP HIGH; see Fig. 5	2.0	0.8	-	ns
		nCP LOW	3.0	2.1	-	ns
		nMR LOW; see Fig. 7	2.0	0.8	-	ns
t _{rec}	recovery time	nMR to nCP; see Fig. 7	2.3	1.3	-	ns

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

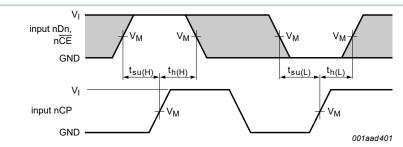
Symbo	l Parameter	Conditions	Min	Typ[1]	Max	Unit
V _{CC} = 3	3.3 V ± 0.3 V			-		
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see Fig. 5	1.8	2.9	4.4	ns
t _{PHL}	HIGH-to-LOW propagation delay	nCP to nQn; see Fig. 5	1.6	2.3	3.6	ns
		nMR to nQn; see Fig. 7	1.8	2.5	3.7	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see Fig. 8	2.0	3.5	5.2	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see Fig. 8	1.7	2.8	3.8	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see Fig. 8	2.4	3.5	4.7	ns
t_{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see Fig. 8	1.9	2.8	3.8	ns
t _{su(H)}	set-up time HIGH	nDn to nCP; see Fig. 6	1.0	0.5	-	ns
, ,		nCE to nCP; see Fig. 6	1.0	0.1	-	ns
t _{su(L)}	set-up time LOW	nDn to nCP; see Fig. 6	1.6	1.1	-	ns
		nCE to nCP; see Fig. 6	0.5	-0.5	-	ns
t _{h(H)}	hold time HIGH	nDn to nCP; see Fig. 6	0.1	-0.5	-	ns
		nCE to nCP; see Fig. 6	1.0	-0.1	-	ns
t _{h(L)}	hold time LOW	nDn to nCP; see Fig. 6	0.1	-0.7	-	ns
		nCE to nCP; see Fig. 6	1.0	0.5	-	ns
t _W	pulse width	nCP HIGH; see Fig. 5	1.5	0.7	-	ns
		nCP LOW	2.5	1.4	-	ns
		nMR LOW; see Fig. 7	2.0	1.5	-	ns
t _{rec}	recovery time	nMR to nCP; see Fig. 7	2.0	1.1	-	ns

^[1] All typical values for V_{CC} = 2.5 V ± 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C. All typical values for V_{CC} = 3.3 V ± 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

10.1. Waveforms and test circuit



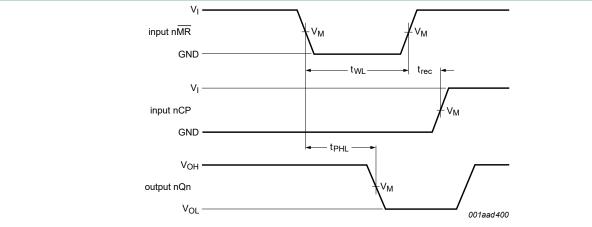
18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state



Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance.

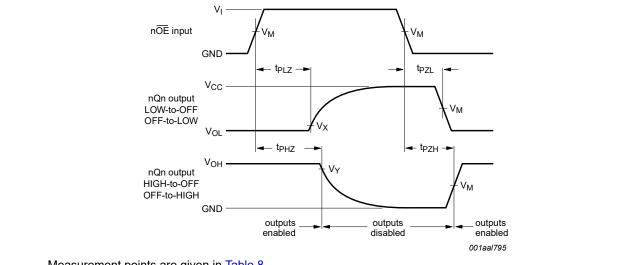
Data set-up and hold times Fig. 6.



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Master reset (nMR) pulse width, master reset (nMR) to output (nQn) propagation delay and master reset Fig. 7. (nMR) to clock (nCP) recovery time



Measurement points are given in Table 8.

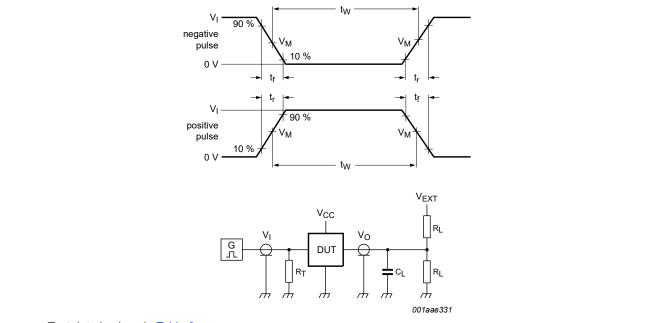
V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

OFF-state to HIGH and LOW propagation delays and LOW and HIGH to OFF-state propagation delays Fig. 8.

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

Table 8. Measurement points

V _{CC}	Input	Output	Dutput							
	V _M	V _M	V _X	V _Y						
≤ 2.7 V	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V						
≥ 3.0 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V						



Test data is given in Table 9.

Definitions test circuit:

R_L = Load resistance;

 C_L = Load capacitance including jig and probe capacitance;

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

 V_{EXT} = Test voltage for switching times.

Fig. 9. Test circuit for measuring switching times

Table 9. Test data

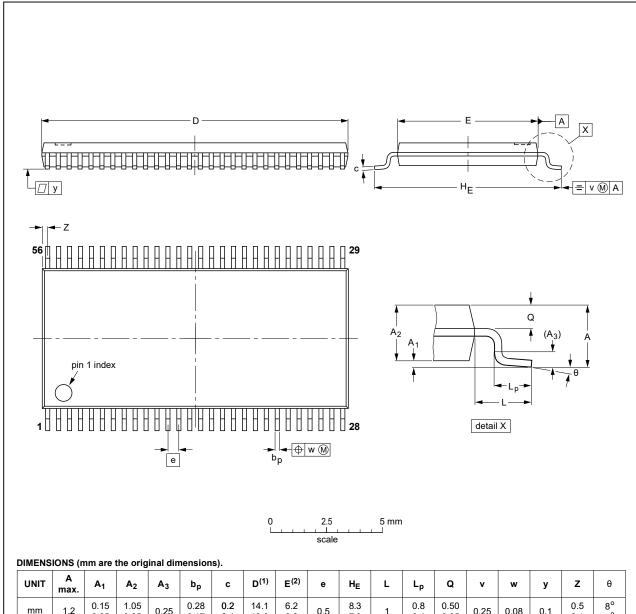
Input	Load		V _{EXT}					
V _I	f_i t_W t_r		t _r , t _f	CL	R_L	t_{PHZ} , t_{PZH}	t _{PLZ} , t _{PZL}	t _{PLH} , t _{PHL}
3.0 V or V _{CC} whichever is less	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V or V _{CC} × 2	open

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11. Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	C	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT364-1		MO-153				99-12-27 03-02-19

Fig. 10. Package outline SOT364-1 (TSSOP56)

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council
MOS	Metal-Oxide Semiconductor

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74ALVT162823 v.4	20240625	Product data sheet	-	74ALVT162823 v.3	
Modifications:	 Section 2: ESD specification updated according to the latest JEDEC standard. Section 1 updated. 				
74ALVT162823 v.3	20180123	Product data sheet	-	74ALVT162823 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74ALVT162823DL (SOT371-1 / SSOP56) removed. 				
74ALVT162823 v.2	20050811	Product data sheet	-	74ALVT162823 v.1	
Modifications:	 The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors. Section 2: modified 'Jedec Std 17' into 'JESD78' Section 10: changed propagation delays. 				
74ALVT162823 v.1	19980827	Product specification	-	-	

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

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